PHILIPS 74ABT_H162245A Electronic component datasheet

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The 74ABT162245A high-performance BiCMOS device combines low static and dynamic power dissipation with high speed. The 74ABT162245A device is a 16-bit transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. The control function implementation minimizes external timing requirements. The device features two Output Enable (1OE, 2OE) inputs for easy cascading and two Direction (1DIR, 2DIR) inputs for direction control.

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INTEGRATED CIRCUITS



Product specification Supersedes data of 1996 Nov 20 IC23 Data Handbook 1998 Feb 25

Philips Semiconductors



74ABT162245A 74ABTH162245A

FEATURES

- 16-bit bidirectional bus interface
- Power-up 3-State
- Multiple V_{CC} and GND pins minimize switching noise
- 3-State buffers
- Output capability: +12mA/–32mA
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200V per Machine Model
- Same part as 74ABT16245A-1
- 74ABTH162245A incorporates bus hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs

DESCRIPTION

The 74ABT162245A high-performance BiCMOS device combines low static and dynamic power dissipation with high speed.

The 74ABT162245A device is a 16-bit transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. The control function implementation minimizes external timing requirements. The device features two Output Enable ($1\overline{OE}$, $2\overline{OE}$) inputs for easy cascading and two Direction (1DIR, 2DIR) inputs for direction control.

The 74ABT162245A is designed with 30 ohm series resistance in both the upper and lower output structures on both A and B ports. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus receiver/transmitters.

The 74ABT162245A is the same as the 74ABT16245A-1. The part number has been changed to reflect industry standards

Two options are available, 74ABT162245A which does not have the bus hold feature and the 74ABTH162245A which incorporates the bus hold feature.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay nAx to nBx or nBx to nAx	$C_{L} = 50 pF; V_{CC} = 5V$	2.0 3.0	ns
C _{IN}	Input capacitance	$V_{I} = 0V \text{ or } V_{CC}$	3	pF
C _{I/O}	I/O pin capacitance	$V_{O} = 0V \text{ or } V_{CC}$; 3-State	7	pF
Iccz	Quiescent supply current	Outputs disabled; V _{CC} = 5.5V	300	nA
I _{CCL}	Quescent supply current	Outputs Low; $V_{CC} = 5.5V$	10	mA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
48-Pin Plastic SSOP Type III	–40°C to +85°C	74ABT162245A DL	BT162245A DL	SOT370-1
48-Pin Plastic TSSOP Type II	–40°C to +85°C	74ABT162245A DGG	BT162245A DGG	SOT362-1
48-Pin Plastic SSOP Type III	–40°C to +85°C	74ABTH162245A DL	BH162245A DL	SOT370-1
48-Pin Plastic TSSOP Type II	–40°C to +85°C	74ABTH162245A DGG	BH162245A DGG	SOT362-1

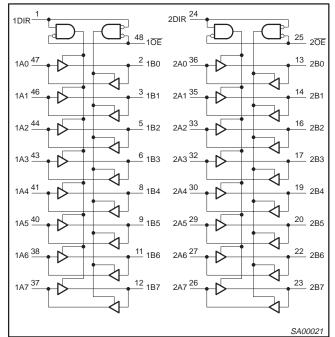
PIN CONFIGURATION

1DIR 1	48	1 0E
1B0 2	47	1A0
1B1 3	46	1A1
GND 4	45	GND
1B2 5	44	1A2
1B3 6	43	1A3
V _{CC} 7	42	VCC
1B4 8	41	1A4
1B5 9	40	1A5
GND 10	39	GND
1B6 [11	38	1A6
1B7 12	37	1A7
2B0 13	36	2A0
2B1 14	35	2A1
GND 15	34	GND
2B2 16	33	2A2
2B3 17	32	2A3
V _{CC} 18	31	VCC
2B4 19	30	2A4
2B5 20	29	2A5
GND 21	28	GND
2B6 22	27	2A6
2B7 23	26	2A7
2DIR 24	25	2 0E
'	SA	00020

PIN DESCRIPTION

SYMBOL	PIN NUMBER	NAME AND FUNCTION
1DIR, 2DIR	1, 24	Direction control inputs (Active-High)
1A0 – 1A7, 2A0 – 2A7	47, 46, 44, 43 41, 40, 38, 37 36, 35, 33, 32 30, 29, 27, 26	Data inputs/outputs (A side)
1B0 – 1B7 2B0 – 2B7	2, 3, 5, 6 8, 9, 11, 12 13, 14, 16, 17 19, 20, 22, 23	Data inputs/outputs (B side)
10E, 20E	48, 25	Output enables
GND	4, 10, 15, 21 28, 34, 39, 45	Ground (0V)
V _{CC}	7, 18, 31, 42	Positive supply voltage

LOGIC SYMBOL



FUNCTION TABLE

INP	JTS	INPUTS/OUTPUTS			
nOE	nDIR	nAx	nBx		
L	L	A = B	Inputs		
L	н	Inputs	B = A		
Н	Х	Z	Z		

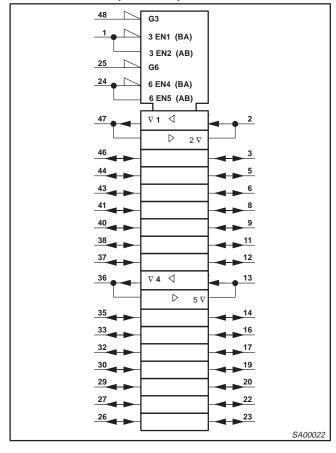
H = HIGH voltage level

L = LOW voltage level

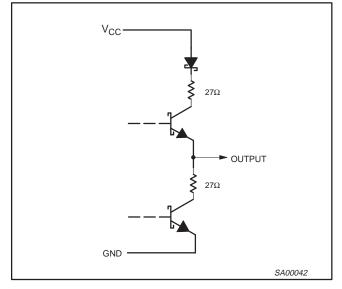
X = D0n't care Z = High impedance "off" state

74ABT162245A 74ABTH162245A

LOGIC SYMBOL (IEEE/IEC)



SCHEMATIC OF EACH OUTPUT



ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V ₁ < 0	-18	mA
VI	DC input voltage ³		-1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +5.5	V
1		output in Low state	128	
IOUT	DC output current	output in High state	-64	mA
T _{stg}	Storage temperature range		–65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

 The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	ITS	UNIT V	
STMBOL	FARAINETER	Min	Max		
V _{CC}	DC supply voltage	4.5	5.5	V	
VI	Input voltage	0	V _{CC}	V	
V _{IH}	High-level input voltage	2.0		V	
V _{IL}	Low-level Input voltage		0.8	V	
I _{ОН}	High-level output current		-32	mA	
I _{OL}	Low-level output current		12	mA	
Δt/Δv	Input transition rise or fall rate	0	10	ns/V	
T _{amb}	Operating free-air temperature range	-40	+85	°C	

DC ELECTRICAL CHARACTERISTICS

						LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS		Ta	_{mb} = +25	S°C	T _{amb} = to +	- –40°C 85°C	UNIT
				Min	Тур	Max	Min	Max	1
V _{IK}	Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$			-0.9	-1.2		-1.2	V
		V_{CC} = 4.5V; I_{OH} = –3mA; V_{I} = V_{IL} or V_{IH}		2.5	2.9		2.5		V
V _{OH}	High-level output voltage	V_{CC} = 5.0V; I_{OH} = -3mA; V_I = V_{IL} or V_{IH}		3.0	3.4		3.0		V
		V_{CC} = 4.5V; I_{OH} = -32mA; V_I = V_{IL} or V_{IH}		2.0	2.4		2.0		V
M	Low-level output voltage	V_{CC} = 4.5V; I_{OL} = 8mA; V_I = V_{IL} or V_{IH}			0.46	0.65		0.65	V
V _{OL}	Low-level output voltage	V_{CC} = 4.5V; I_{OL} = 12mA; V_I = V_{IL} or V_{IH}			0.50	0.80		0.80	V
I _I	Input leakage current	$V_{CC} = 5.5V; V_I = GND \text{ or } 5.5V$ Cont pin	-		±0.01	±1.0		±1.0	μA
	Bus hold current	$V_{CC} = 4.5 V; V_I = 0.8 V$		50			50		
I _{HOLD}	A and B inputs ⁴	$V_{CC} = 5.5V; V_{I} = 2.0V$		-75			-75		μA
	74ABTH162245A	$V_{CC} = 5.5V; V_I = 0 \text{ to } 5.5V$		±500					
I _{OFF}	Power-off leakage current	V_{CC} = 0.0V; V_{O} or $V_{I}~\leq~4.5V$			±5.0	±100		±100	μΑ
I _{PU} /I _{PD}	Power-up/down 3-State output current ³	V_{CC} = 2.0V; V_{O} = 0.5V; V_{I} = GND or V_{CC} V_{OE} = Don't care	,		±5.0	±50		±50	μΑ
I _{IH} +I _{OZH}	3-State output High current	V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = V_{IL} or V_{IH}			0.5	10		10	μΑ
I _{IL} +I _{OZL}	3-State output Low current	V_{CC} = 5.5V; V_O = 0.0V; V_I = V_{IL} or V_{IH}			-0.5	-10		-10	μΑ
I _{CEX}	Output high leakage current	V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = GND or V_{CC}			5.0	50		50	μΑ
Ι _Ο	Output current ¹	$V_{CC} = 5.5$ V; $V_{O} = 2.5$ V		-50	-92	-180	-50	-180	mA
I _{CCH}		V_{CC} = 5.5V; Outputs High, V_{I} = GND or V	′сс		0.3	0.70		0.70	mA
I _{CCL}	Quiescent supply current	V_{CC} = 5.5V; Outputs Low, V _I = GND or V	СС		10	19		19	mA
I _{CCZ}		V_{CC} = 5.5V; Outputs 3-State; V ₁ = GND or V _{CC}			0.3	0.70		0.70	mA
		Outputs enabled, one data input at 3.4V, other inputs at V _{CC} or GND; V _{CC} = 5.5V			400	700		700	μA
		Outputs 3-State, one data input at 3.4V, of inputs at V_{CC} or GND; $V_{CC} = 5.5V$ 74ABT162245A	other		1.0	50		50	μA
ΔI_{CC}	input pin-	Outputs 3-State, one data input at 3.4V, of inputs at V_{CC} or GND; $V_{CC} = 5.5V$ 74ABTH162245A	other		100	250		250	μA
		Control pins, outputs disabled, one enablinput at 3.4V, other inputs at V _{CC} or GND $V_{CC} = 5.5V$			400	700		700	μA

NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

2. This is the increase in supply current for each input at 3.4V.

3. This parameter is valid for any V_{CC} between 0V and 2.1V, with a transition time of up to 10msec. From V_{CC} = 2.1V to V_{CC} = 5 \pm 10% a transition time of up to 100 µsec is permitted.

4. This is the bus hold overdrive current required to force the input to the opposite logic state.

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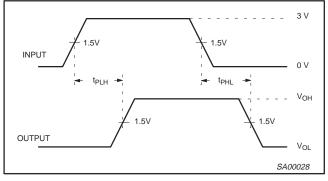
AC CHARACTERISTICS

GND = 0V; $t_R = t_F$ = 2.5ns; C_L = 50pF, R_L = 500 Ω

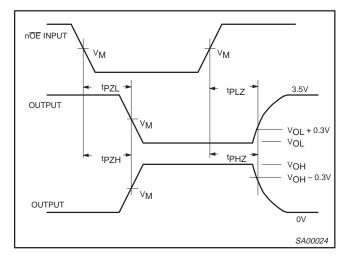
					LIMIT	ſS		
SYMBOL	PARAMETER	WAVEFORM	T _a V	_{mb} = +25° _{CC} = +5.0	C V	$T_{amb} = -40^{\circ}$ $V_{CC} = +5.$	°C to +85°C .0V ±0.5V	UNIT
			Min	Тур	Мах	Min	Max	
t _{PLH} t _{PHL}	Propagation delay nAx to nBx or nBx to nAx	1	1.0 1.5	2.0 3.0	3.3 4.5	1.0 1.5	3.5 4.9	ns
t _{PZH} t _{PZL}	Output enable time to High and Low level	2	1.5 2.0	3.1 5.0	4.3 6.1	1.5 2.0	5.0 7.0	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low level	2	1.7 1.5	3.5 3.2	4.8 4.5	1.7 1.5	5.4 4.9	ns

AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to 3.0V



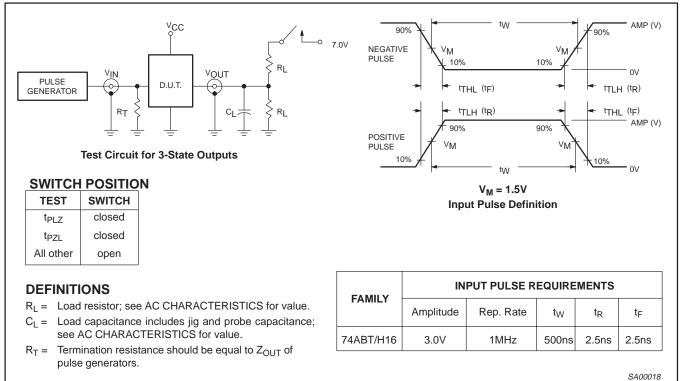
Waveform 1. Input to Output Propagation Delays

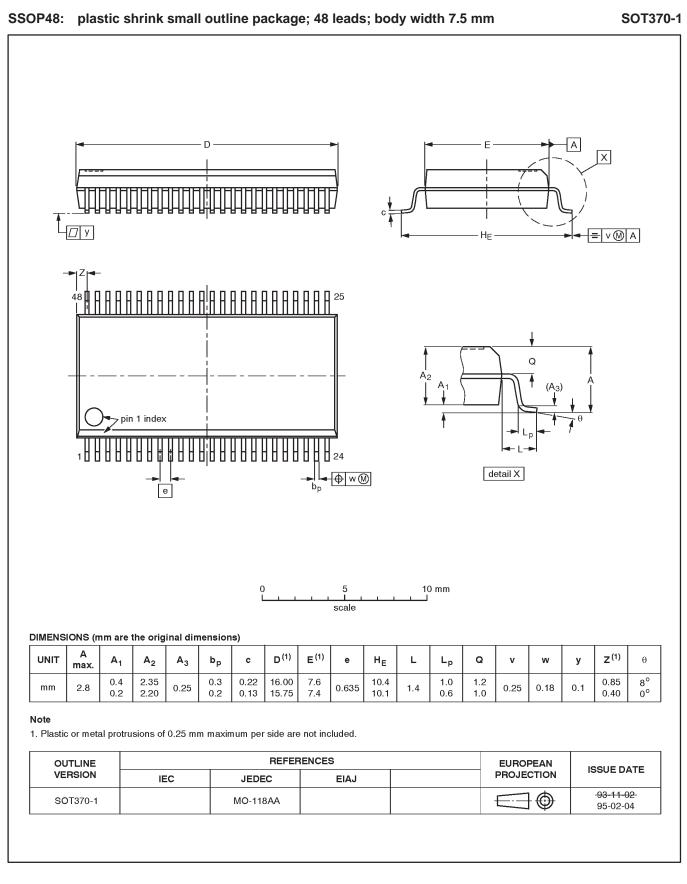


Waveform 2. 3-State Output Enable and Disable Times

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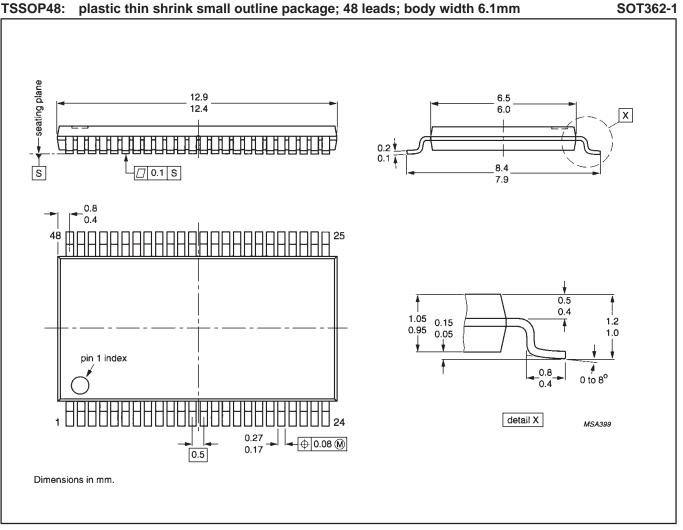
TEST CIRCUIT AND WAVEFORMS





Product specification

74ABT162245A 74ABTH162245A



TSSOP48:

NOTES

74ABT162245A 74ABTH162245A

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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